# **RF Transformer**

0.25 to 300 MHz  $50\Omega$ 

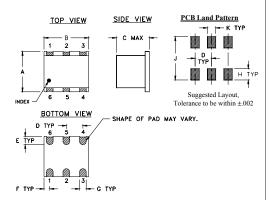
## **Maximum Ratings**

Operating Temperature	-20°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25W
DC Current	30mA
Pormanant damage may occur if any	of those limits are exceeded

### **Pin Connections**

PRIMARY DOT	4
PRIMARY	6
SECONDARY DOT	3
SECONDARY	1
NOT USED	2,5

## **Outline Drawing**



## Outline Dimensions (inch)

F	<b>E</b>	<b>D</b>	<b>C</b>	<b>B</b>	<b>A</b>
. <b>055</b>	. <b>050</b>	. <b>100</b>	. <b>20</b>	. <b>31</b>	. <b>250</b>
1.40	1.27	2.54	5.08	7.87	6.35
wt		K	J	H	G
grams		.050	. <b>270</b>	. <b>070</b>	.040
0.50		1.27	6.86	1.78	1.02

# Config. C SEC

### **Features**

- wideband, 0.25 to 300 MHz
- excellent return loss

## **Applications**

- · impedance matching
- VHF/UHF
- receivers/transmitters

## TX1.5-1+



Generic photo used for illustration purposes only CASE STYLE: TT240

+RoHS Compliant The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

## **Transformer Electrical Specifications**

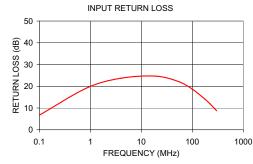
$^{\Omega}$ RATIO	FREQUENCY (MHz)	3 dB MHz	INSERTION LOSS*	1 dB MHz
1.5	0.25-300	0.25-300	0.3-150	0.5-80

<sup>\*</sup> Insertion Loss is referenced to mid-band loss, 0.4 dB typ.

## **Typical Performance Data**

FREQUE (MHz			
0.10	1.96	6.70	
0.85	0.64	19.19	
4.00	0.38	23.71	
18.93	0.36	24.68	
53.35	0.42	22.20	
99.34	0.61	18.74	
175.64	0.89	14.16	
223.68	0.96	11.88	
261.29	1.03	10.26	
300.00	1.19	8.75	





- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

  B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.

  C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

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## Typical Performance Curves

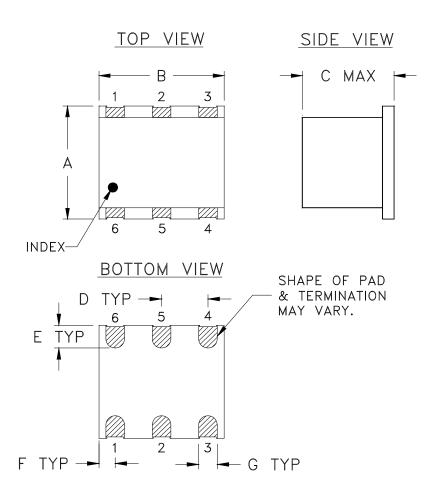




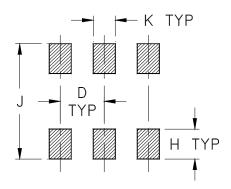
# Case Style

**TT240** 

## **Outline Dimensions**



## **PCB Land Pattern**



Suggested Layout, Tolerance to be within ±.002

CASE#	A	В	С	D	Е	F	G	Н	J	K	WT. GRAM
TT240	.250 (6.35)	.31 (7.87)	.20 (5.08)	.100 (2.54)	.050 (1.27)	.055 (1.40)	.040 (1.02)	.070 (1.78)	.270 (6.86)	.050 (1.27)	.50

Dimensions are in inches (mm). Tolerances: 2Pl. ± .01; 3 Pl. ± .005

## **Notes:**

- 1. Case material: Ceramic.
- 2. Termination finish:

For RoHS Case Styles:  $2-10\mu$  inch (.05-.25 microns) Gold plate over  $100-300~\mu$  inch (2.54-7.62 microns) Nickel plate.

All models, (+) suffix.

For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



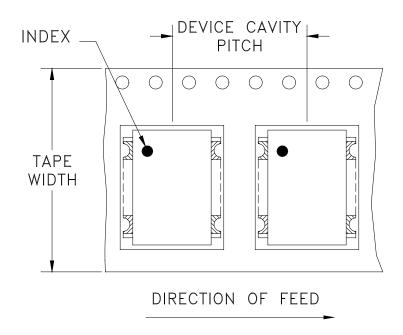


P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



# Tape & Reel Packaging TR-F2

## DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size,	Devices per Reel
		inches	See note
			10
			20
		7	50
16	12		100
			200
		12	500
		13	1000

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf





## **Environmental Specifications**

ENV02

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

ENV02 Rev: A

02/25/11

M130240 File: ENV02.pdf

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